

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

	Stephan Grunow, et al.	Docket No.:	TI-35917
Serial No:	10/688,452	Filed:	10/18/2003
Art Unit:	2841	Examiner:	Jeremy C. Norris
Customer No.:	23494	Conf. No.:	1572
Title:	A Stacked Interconnect Structure Between Copper Lines of a Semiconductor Circuit		

ELECTION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

With respect to the Restriction Requirement mailed on 03/28/2006, the Examiner has restricted the instant application to the invention of Group I (Claims 1-12), or Group II (Claims 13-21). In light of this, Applicants elect to pursue Group I, (Claims 1-12) without traverse.

Respectfully submitted,

/Jacqueline J. Garner/
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